

4V Drive Nch + Nch MOSFET

QS8K11

● Structure

Silicon N-channel MOSFET

● Features

- 1) Low on-resistance.
- 2) High power package(TSMT8).
- 3) Low voltage drive(4V drive).

● Application

Switching

● Packaging specifications

Type	Package	Taping
	Code	TCR
	Basic ordering unit (pieces)	3000
QS8K11		○

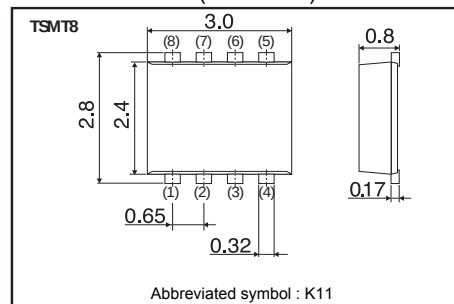
● Absolute maximum ratings (Ta = 25°C)

Parameter		Symbol	Limits	Unit
Drain-source voltage		V_{DSS}	30	V
Gate-source voltage		V_{GSS}	±20	V
Drain current	Continuous	I_D	±3.5	A
	Pulsed	I_{DP} *1	±12	A
Source current (Body Diode)	Continuous	I_s	1	A
	Pulsed	I_{sp} *1	12	A
Power dissipation		P_D *2	1.5	W / TOTAL
			1.25	W / ELEMENT
Channel temperature		Tch	150	°C
Range of storage temperature		Tstg	-55 to +150	°C

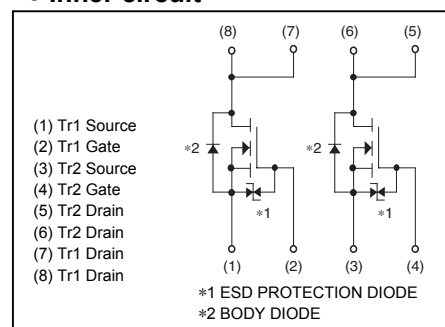
 *1 $P_w \leq 10\mu s$, Duty cycle $\leq 1\%$

*2 Mounted on a ceramic board.

● Dimensions (Unit : mm)



● Inner circuit



● **Electrical characteristics** (Ta = 25°C)

<It is the same ratings for Tr1 and Tr2.>

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gatesource leakage	I_{GSS}	–	–	±10	μA	$V_{GS}=\pm 20V$, $V_{DS}=0V$
Drainsource breakdown voltage	$V_{(BR)DSS}$	30	–	–	V	$I_D=1mA$, $V_{GS}=0V$
Zero gate voltage drain current	I_{DSS}	–	–	1	μA	$V_{DS}=30V$, $V_{GS}=0V$
Gate threshold voltage	$V_{GS(th)}$	1.0	–	2.5	V	$V_{DS}=10V$, $I_D=1mA$
Static drainsource onstate resistance	$R_{DS(on)}^*$	–	35	50	mΩ	$I_D=3.5A$, $V_{GS}=10V$
		–	45	65		$I_D=3.5A$, $V_{GS}=4.5V$
		–	50	70		$I_D=3.5A$, $V_{GS}=4.0V$
Forward transfer admittance	$ Y_{fs} ^*$	2.2	–	–	S	$I_D=3.5A$, $V_{DS}=10V$
Input capacitance	C_{iss}	–	180	–	pF	$V_{DS}=10V$
Output capacitance	C_{oss}	–	70	–	pF	$V_{GS}=0V$
Reverse transfer capacitance	C_{rss}	–	35	–	pF	$f=1MHz$
Turnon delay time	$t_{d(on)}^*$	–	10	–	ns	$I_D=1.7A$, $V_{DD}=15V$
Rise time	t_r^*	–	25	–	ns	$V_{GS}=10V$
Turnoff delay time	$t_{d(off)}^*$	–	25	–	ns	$R_L=8.87\Omega$
Fall time	t_f^*	–	7	–	ns	$R_G=10\Omega$
Total gate charge	Q_g^*	–	3.3	–	nC	$I_D=3.5A$, $V_{DD}=15V$
Gatesource charge	Q_{gs}^*	–	1.0	–	nC	$V_{GS}=5V$
Gatedrain charge	Q_{gd}^*	–	1.0	–	nC	

*Pulsed

● **Body diode characteristics** (Source-Drain) (Ta = 25°C)

<It is the same ratings for Tr1 and Tr2.>

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward Voltage	V_{SD}^*	–	–	1.2	V	$I_S=3.5A$, $V_{GS}=0V$

*Pulsed

●Electrical characteristic curves (Ta=25°C)

Fig.1 Typical Output Characteristics(I)

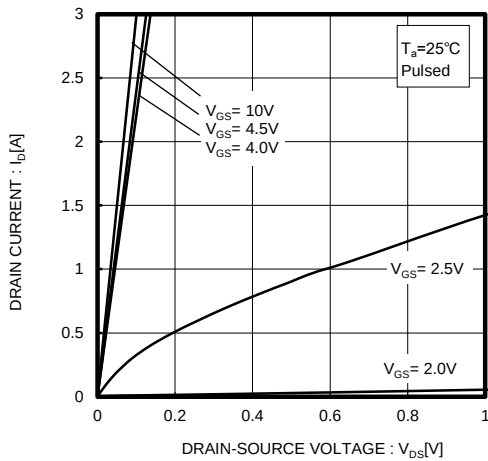


Fig.2 Typical Output Characteristics(II)

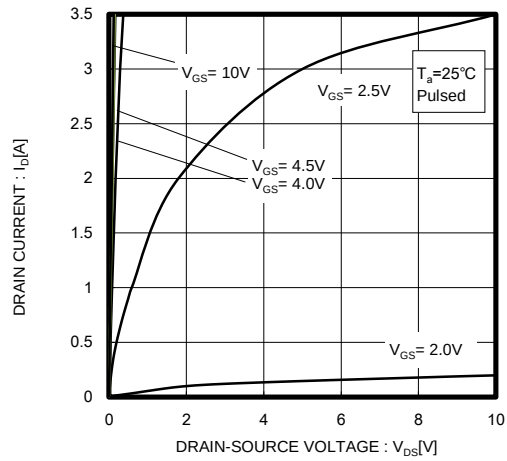


Fig.3 Typical Transfer Characteristics

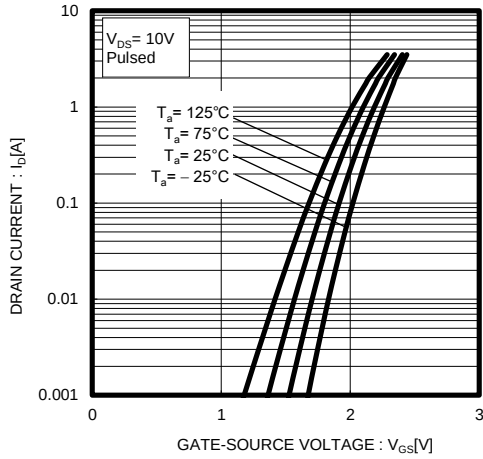


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current(I)

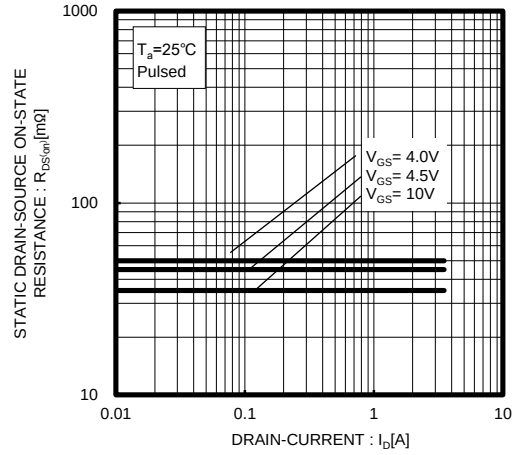


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current(II)

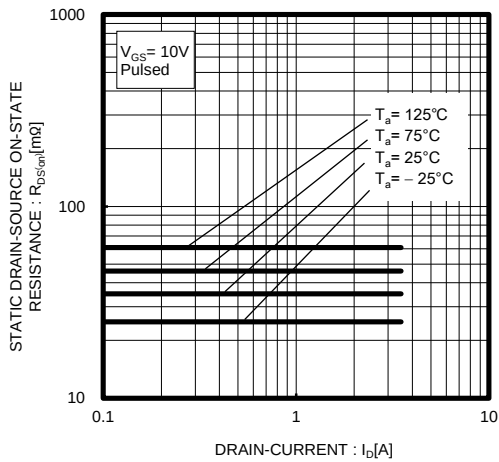


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current(III)

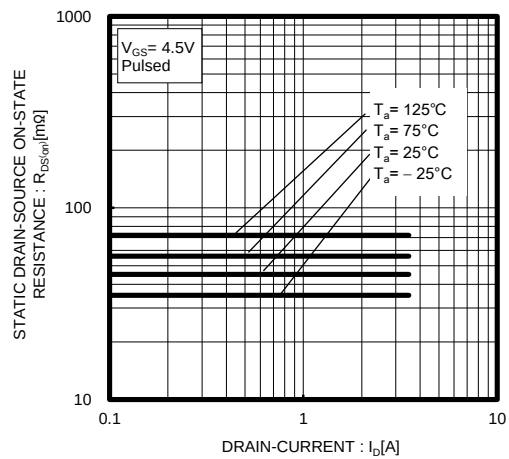


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current(I_D)

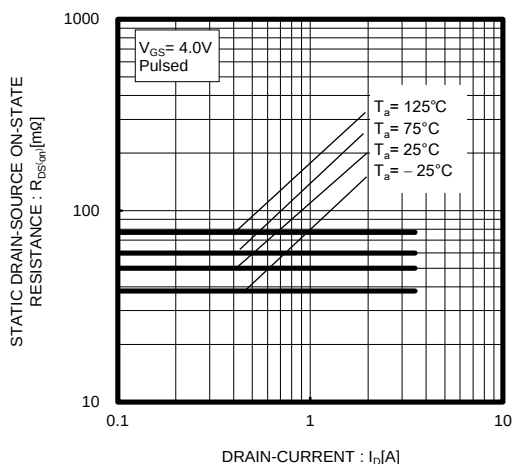


Fig.8 Forward Transfer Admittance vs. Drain Current

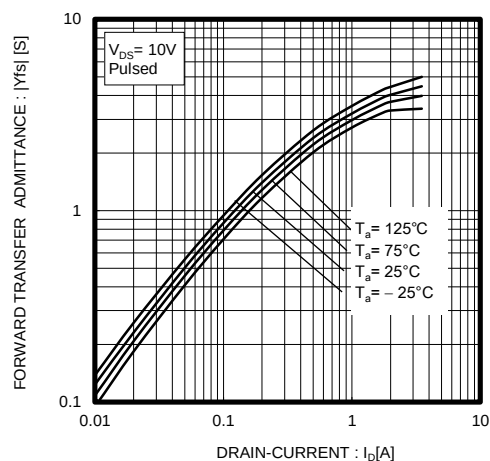


Fig.9 Reverse Drain Current vs. Source-Drain Voltage

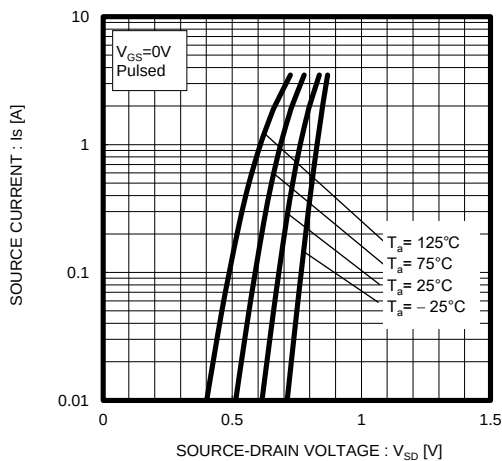


Fig.10 Static Drain-Source On-State Resistance vs. Gate Source Voltage

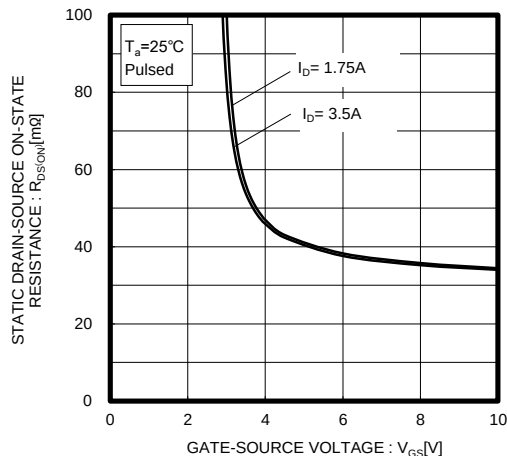


Fig.11 Switching Characteristics

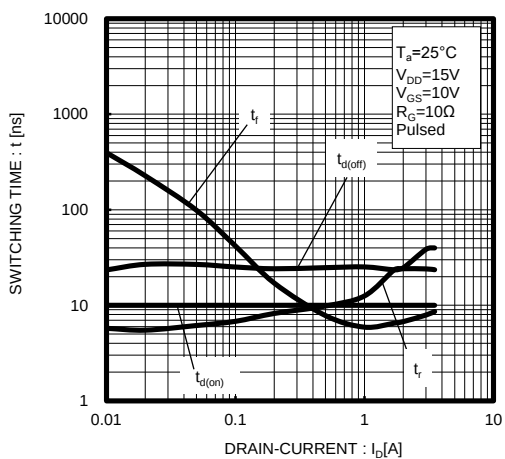


Fig.12 Dynamic Input Characteristics

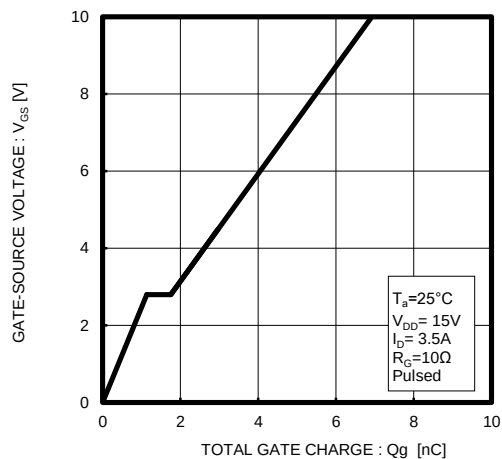


Fig.13 Typical Capacitance vs. Drain-Source Voltage

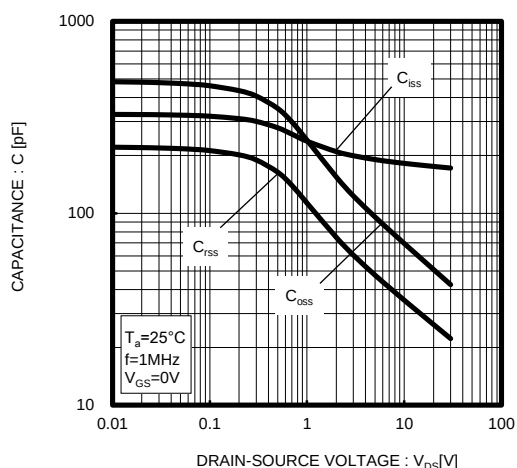


Fig.14 Maximum Safe Operating Area

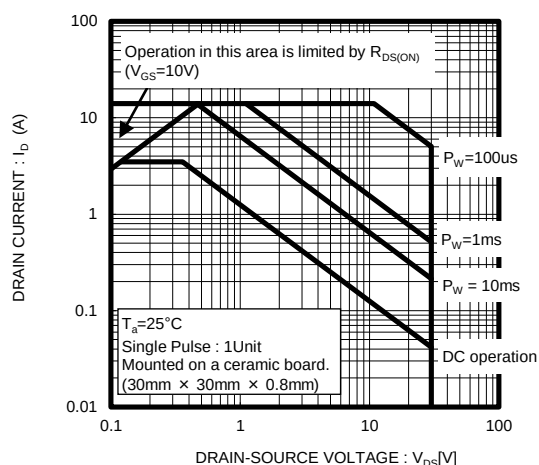
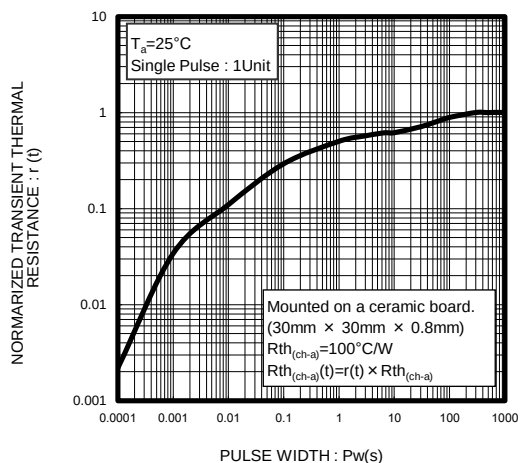


Fig.15 Normalized Transient Thermal Resistance vs. Pulse Width



● Measurement circuits

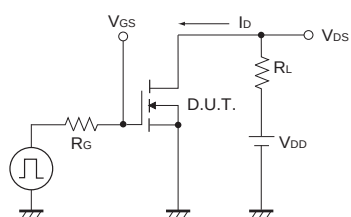


Fig.1-1 Switching Time Measurement Circuit

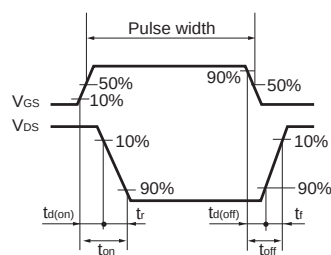


Fig.1-2 Switching Waveforms

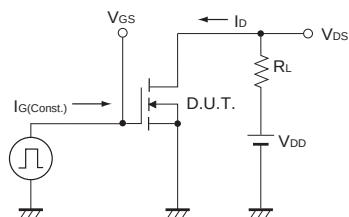


Fig.2-1 Gate Charge Measurement Circuit

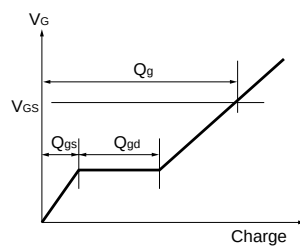


Fig.2-2 Gate Charge Waveform

● Notice

This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

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